

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	24	((("5611481") or ("3276750") or ("10321671") or ("0766310") or ("2159047") or ("0098046") or ("9213702") or ("9326465") or ("2000243785"))).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/20 12:45
S2	2	("20040169286").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/20 12:53
S3	1898	(257/737).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/20 12:54
S4	25	("5007163" "5391514").PN. OR ("5611481").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:21
S5	12	"liquid phase diffusion" and sn and alloy	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:22
S6	221	"liquid phase diffusion"	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:31
S7	5626	diffusion adj bond\$3	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:31
S8	437	diffusion adj bond\$3 and sn	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:35
S9	768	diffusion adj bond\$3 and eutectic	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:35
S10	222	diffusion adj bond\$3 with eutectic	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:35

S11	52	(US-20010009297-\$ or US-20010013655-\$ or US-20010055146-\$ or US-20020050404-\$ or US-20020132463-\$ or US-20030022479-\$ or US-20030150635-\$ or US-20030173665-\$ or US-20030230806-\$ or US-20040004292-\$ or US-20040113272-\$ or US-20040169277-\$ or US-20040169286-\$ or US-20040178503-\$ or US-20050011937-\$ or US-20050093149-\$ or US-20050104208-\$).did. or (US-4764804-\$ or US-5421507-\$ or US-5461261-\$ or US-5611481-\$ or US-5641990-\$ or US-5666008-\$ or US-5672913-\$ or US-5734199-\$ or US-5773897-\$ or US-5796591-\$ or US-5889326-\$ or US-5930598-\$ or US-6002172-\$ or US-6011313-\$ or US-6027957-\$ or US-6088236-\$ or US-6130476-\$ or US-6153940-\$ or US-6190940-\$ or US-6198169-\$ or US-6249051-\$ or US-6281581-\$ or US-6333554-\$ or US-6369451-\$ or US-6433425-\$ or US-6492197-\$). did. or (US-6507118-\$ or US-6740823-\$ or US-6858111-\$ or US-6894389-\$).did. or (JP-10321671-\$ or JP-2000243785-\$).did. or (JP-08031835-\$ or JP-10321671-\$ or JP-2000243785-\$).did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/11/16 14:13
S12	77	bump with (align or alignment or self-align) and (resin with underfill)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/16 14:21
S13	1092	"flip chip" and self-align\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/16 14:23
S14	375	"flip chip" and self-align\$4 with (bump or ball or electrode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/16 14:24